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#### Understanding <u>Embedded - CPLDs (Complex</u> <u>Programmable Logic Devices)</u>

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixedfunction ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

#### **Applications of Embedded - CPLDs**

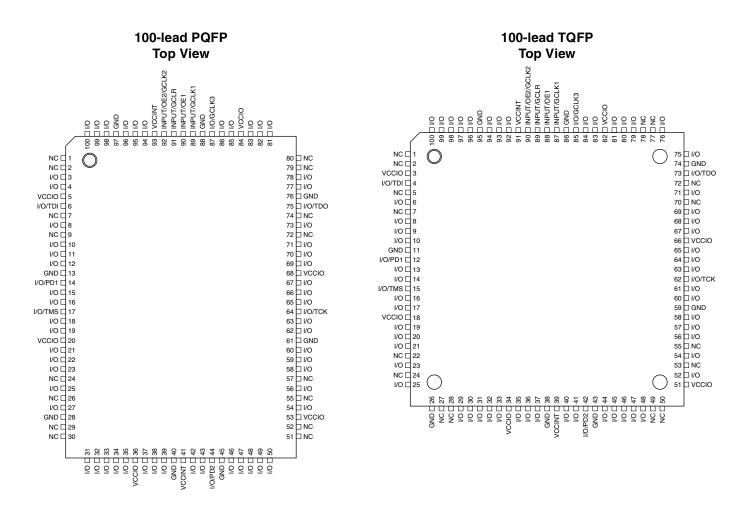
#### Details

E·XFI

Product Status	Obsolete
Programmable Type	In System Programmable (min 10K program/erase cycles)
Delay Time tpd(1) Max	10 ns
Voltage Supply - Internal	4.5V ~ 5.5V
Number of Logic Elements/Blocks	- ·
Number of Macrocells	64
Number of Gates	· ·
Number of I/O	64
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atf1504as-10ai100

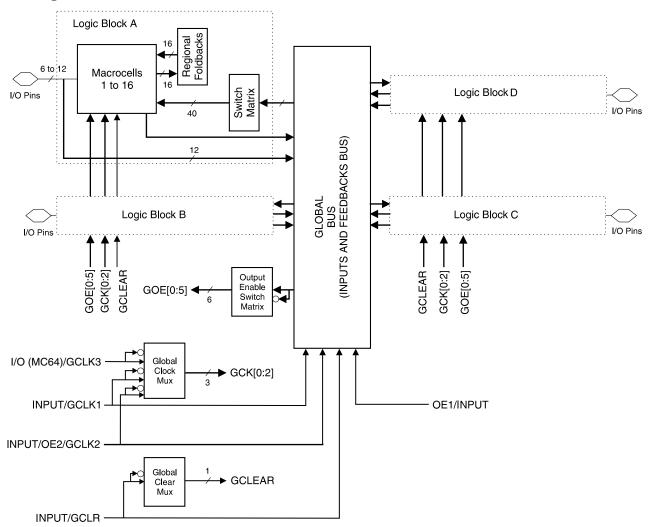
Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong





### **Block Diagram**



Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the contents of the ATF1504AS. Two bytes (16 bits) of User Signature are accessible to the user for purposes such as storing project name, part number, revision or date. The User Signature is accessible regardless of the state of the security fuse.

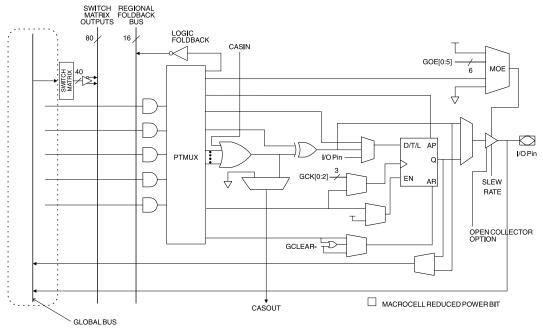
The ATF1504AS device is an in-system programmable (ISP) device. It uses the industry-standard 4-pin JTAG interface (IEEE Std. 1149.1), and is fully-compliant with JTAG's Boundary-scan Description Language (BSDL). ISP allows the device to be programmed without removing it from the printed circuit board. In addition to simplifying the manufacturing flow, ISP also allows design modifications to be made in the field via software.



### Foldback Bus

Each macrocell also generates a foldback product term. This signal goes to the regional bus and is available to four macrocells. The foldback is an inverse polarity of one of the macrocell's product terms. The sixteen foldback terms in each region allow generation of high fan-in sum terms (up to sixteen product terms) with a nominal additional delay.





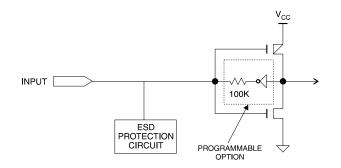




# Programmable Pinkeeper Option for Inputs and I/Os

The ATF1504AS offers the option of programming all input and I/O pins so that pinkeeper circuits can be utilized. When any pin is driven high or low and then subsequently left floating, it will stay at that previous high- or low-level. This circuitry prevents unused input and I/O lines from floating to intermediate voltage levels, which causes unnecessary power consumption and system noise. The keeper circuits eliminate the need for external pull-up resistors and eliminate their DC power consumption.

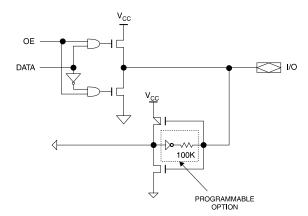
### Input Diagram



## Speed/Power Management

The ATF1504AS has several built-in speed and power management features. The ATF1504AS contains circuitry that automatically puts the device into a low-power standby mode when no logic transitions are occurring. This not only reduces power consumption during inactive periods, but also provides proportional power savings for most applications running at system speeds below 5 MHz. This feature may be selected as a device option.

### I/O Diagram



To further reduce power, each ATF1504AS macrocell has a Reduced Power bit feature. This feature allows individual macrocells to be configured for maximum power savings. This feature may be selected as a design option.

All ATF1504AS also have an optional power-down mode. In this mode, current drops to below 10 mA. When the power-down option is selected, either PD1 or PD2 pins (or both) can be used to power-down the part. The power-down option is selected in the design source file. When enabled, the device goes into power-down when either PD1 or PD2 is high. In the power-down mode, all internal logic signals are latched and held, as are any enabled outputs.



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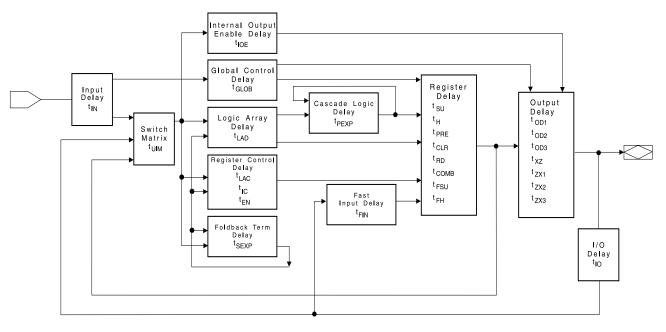
Programming	ATF1504AS devices are in-system programmable (ISP) devices utilizing the 4-pin JTAG protocol. This capability eliminates package handling normally required for programming and facilitates rapid design iterations and field changes.
	Atmel provides ISP hardware and software to allow programming of the ATF1504AS via the PC. ISP is performed by using either a download cable or a comparable board tester or a simple microprocessor interface.
	To facilitate ISP programming by the Automated Test Equipment (ATE) vendors. Serial Vector Format (SVF) files can be created by Atmel provided software utilities.
	ATF1504AS devices can also be programmed using standard third-party programmers. With third-party programmer, the JTAG ISP port can be disabled thereby allowing four additional I/O pins to be used for logic.
	Contact your local Atmel representatives or Atmel PLD applications for details.
ISP Programming Protection	The ATF1504AS has a special feature that locks the device and prevents the inputs and I/O from driving if the programming process is interrupted for any reason. The inputs and I/O default to high-Z state during such a condition. In addition the pin-keeper option preserves the former state during device programming, if this circuit were previously programmed on the device. This prevents disturbing the operation of other circuits in the system while the ATF1504AS is being programmed via ISP.
	All ATF1504AS devices are initially shipped in the erased state thereby making them ready to use for ISP.
	Note: For more information refer to the "Designing for In-System Programmability with Atmel CPLDs" application note.

# AC Characteristics (Continued)

		-7		-10		-15		-20		-25		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	Units
f <sub>MAX</sub>	Maximum Clock Frequency	166.7		125		100		83.3		60		MHz
t <sub>IN</sub>	Input Pad and Buffer Delay		0.5		0.5		2		2		2	ns
t <sub>IO</sub>	I/O Input Pad and Buffer Delay		0.5		0.5		2		2		2	ns
t <sub>FIN</sub>	Fast Input Delay		1		1		2		2		2	ns
t <sub>SEXP</sub>	Foldback Term Delay		4		5		8		10		12	ns
t <sub>PEXP</sub>	Cascade Logic Delay		0.8		0.8		1		1		1.2	ns
t <sub>LAD</sub>	Logic Array Delay		3		5		6		7		8	ns
t <sub>LAC</sub>	Logic Control Delay		3		5		6		7		8	ns
t <sub>IOE</sub>	Internal Output Enable Delay		2		2		3		3		4	ns
t <sub>OD1</sub>	Output Buffer and Pad Delay (Slow slew rate = OFF; $V_{CCIO} = 5V; C_L = 35 pF$ )		2		1.5		4		5		6	ns
t <sub>OD2</sub>	Output Buffer and Pad Delay (Slow slew rate = OFF; $V_{CCIO} = 3.3V$ ; $C_L = 35 \text{ pF}$ )		2.5		2.0		5		6		7	ns
t <sub>OD3</sub>	Output Buffer and Pad Delay (Slow slew rate = ON; $V_{CCIO} = 5V$ or 3.3V; $C_L = 35 \text{ pF}$ )		5		5.5		8		10		10	ns

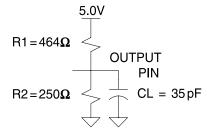
Note: See ordering information for valid part numbers.

# **Timing Model**





# **Output AC Test Loads**



Note: \*Numbers in parenthesis refer to 3.0V operating conditions (preliminary).

## **Power-down Mode**

The ATF1504AS includes an optional pin-controlled power-down feature. When this mode is enabled, the PD pin acts as the power-down pin. When the PD pin is high, the device supply current is reduced to less than 10 mA. During power-down, all output data and internal logic states are latched internally and held. Therefore, all registered and combinatorial output data remain valid. Any outputs that were in a high-Z state at the onset will remain at high-Z. During power-down, all input signals except the power-down pin are blocked. Input and I/O hold latches remain active to ensure that pins do not float to indeterminate levels, further reducing system power. The power-down mode feature is enabled in the logic design file or as a fitted or translated s/w option. Designs using the power-down pin may not use the PD pin as a logic array input. However, all other PD pin macrocell resources may still be used, including the buried feedback and foldback product term array inputs.

# Power Down AC Characteristics<sup>(1)(2)</sup>

		-7		-10		-15		-20		-25		
Symbol	Parameter		Max	Min	Max	Min	Max	Min	Max	Min	Max	Units
t <sub>IVDH</sub>	Valid I, I/O before PD High	7		10		15		20		25		ns
t <sub>GVDH</sub>	Valid OE <sup>(2)</sup> before PD High	7		10		15		20		25		ns
t <sub>CVDH</sub>	Valid Clock <sup>(2)</sup> before PD High	7		10		15		20		25		ns
t <sub>DHIX</sub>	I, I/O Don't Care after PD High		12		15		25		30		35	ns
t <sub>DHGX</sub>	OE <sup>(2)</sup> Don't Care after PD High		12		15		25		30		35	ns
t <sub>DHCX</sub>	Clock <sup>(2)</sup> Don't Care after PD High		12		15		25		30		35	ns
t <sub>DLIV</sub>	PD Low to Valid I, I/O		1		1		1		1		1	μs
t <sub>DLGV</sub>	PD Low to Valid OE (Pin or Term)		1		1		1		1		1	μs
t <sub>DLCV</sub>	PD Low to Valid Clock (Pin or Term)		1		1		1		1		1	μs
t <sub>DLOV</sub>	PD Low to Valid Output		1		1		1		1		1	μs

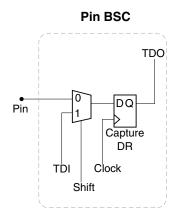
Notes: 1. For slow slew outputs, add  $t_{SSO}$ .

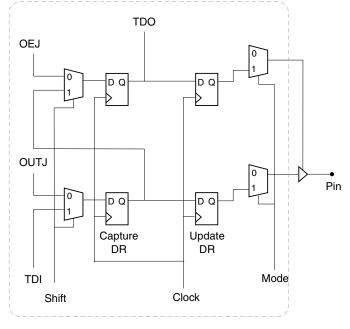
2. Pin or product term.

3. Includes  $t_{\text{RPA}}$  due to reduced power bit enabled.



# **BSC Configuration for Macrocell**





Macrocell BSC

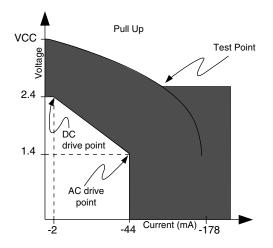




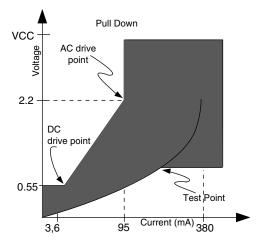
### **PCI Compliance**

The ATF1504AS also supports the growing need in the industry to support the new Peripheral Component Interconnect (PCI) interface standard in PCI-based designs and specifications. The PCI interface calls for high current drivers, which are much larger than the traditional TTL drivers. In general, PLDs and FPGAs parallel outputs to support the high current load required by the PCI interface. The ATF1504AS allows this without contributing to system noise while delivering low output-to-output skew. Having a programmable high drive option is also possible without increasing output delay or pin capacitance. The PCI electrical characteristics appear on the next page.

## PCI Voltage-to-current Curves for +5V Signaling in Pull-up Mode



# PCI Voltage-to-current Curves for +5V Signaling in Pull-down Mode





# **ATF1504AS Dedicated Pinouts**

	44-lead	44-lead	68-lead	84-lead	100-lead	100-lead
Dedicated Pin	TQFP	J-lead	J-lead	J-lead	PQFP	TQFP
INPUT/OE2/GCLK2	40	2	2	2	92	90
INPUT/GCLR	39	1	1	1	91	89
INPUT/OE1	38	44	68	84	90	88
INPUT/GCLK1	37	43	67	83	89	87
I/O /GCLK3	35	41	65	81	87	85
I/O/PD (1,2)	5, 19	11, 25	17, 37	20, 46	14, 44	12, 42
I/O/TDI (JTAG)	1	7	12	14	6	4
I/O/TMS (JTAG)	7	13	19	23	17	15
I/O/TCK (JTAG)	26	32	50	62	64	62
I/O/TDO (JTAG)	32	38	57	71	75	73
GND	4, 16, 24, 36	10, 22, 30, 42	6, 16, 26, 34, 38, 48, 58, 66	7, 19, 32, 42, 47, 59, 72, 82	13, 28, 40, 45, 61, 76, 88, 97	11, 26, 38, 43, 59, 74, 86, 95
V <sub>CCINT</sub>	9, 17, 29, 41	3, 15, 23, 35	3, 35	3, 43	41, 93	39, 91
V <sub>CCIO</sub>	_	_	11, 21, 31, 43, 53, 63	13, 26, 38, 53, 66, 78	5, 20, 36, 53, 68, 84	3, 18, 34, 51, 66, 82
N/C	_	_	_	_	1, 2, 7, 9, 24, 26, 29, 30, 51, 52, 55, 57, 72, 74, 79, 80	1, 2, 5, 7, 22, 24, 27, 28, 49, 50, 53, 55, 70, 72, 77, 78
# of Signal Pins	36	36	52	68	68	68
# User I/O Pins	32	32	48	64	64	64
OE (1, 2)	Global	OE Pins				
GCLR	Global	Clear Pin				
GCLK (1, 2, 3)	Global	Clock Pins				
PD (1, 2)	Power of	down pins				

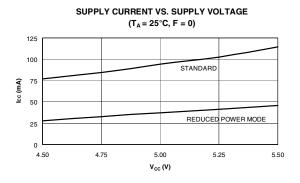
TDI, TMS, TCK, TDO JTAG pins used for boundary-scan testing or in-system programming

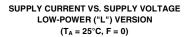
GND Ground Pins

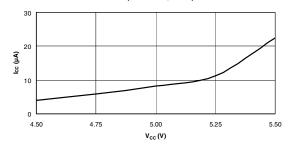
V<sub>CCINT</sub> VCC pins for the device (+5V - Internal)

V<sub>CCIO</sub> VCC pins for output drivers (for I/O pins) (+5V or 3.3V - I/Os)

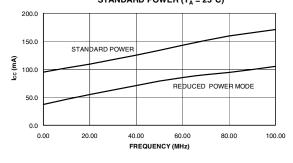


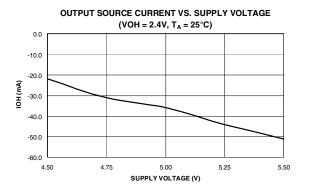


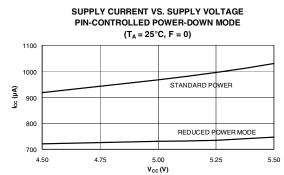




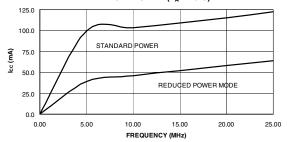
SUPPLY CURRENT VS. FREQUENCY STANDARD POWER ( $T_A = 25^{\circ}C$ )

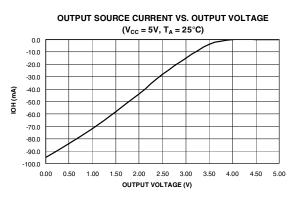


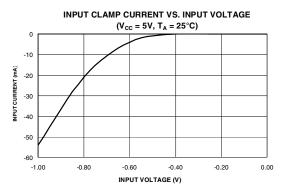


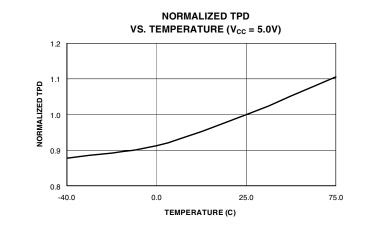


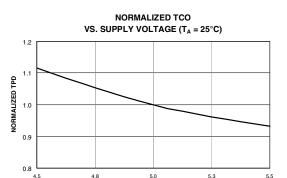
SUPPLY CURRENT VS. FREQUENCY LOW-POWER ("L") VERSION LOW POWER (T<sub>A</sub> = 25°C)

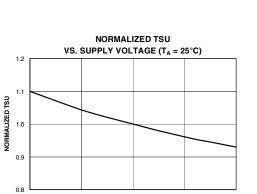












5.0

SUPPLY VOLTAGE (V)

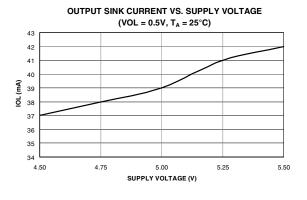
5.3

5.5

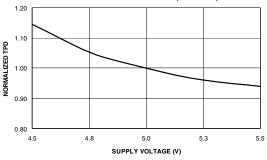
4.5

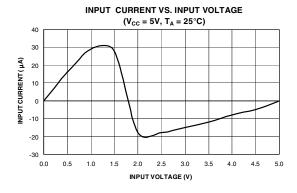
4.8

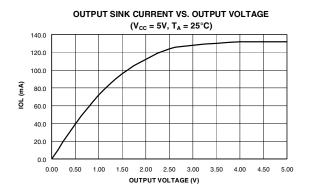
SUPPLY VOLTAGE (V)





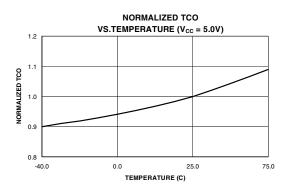


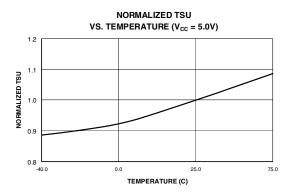












#### t<sub>CO1</sub> t<sub>PD</sub> f<sub>MAX</sub> (MHz) **Ordering Code** Package **Operation Range** (ns) (ns) 7.5 4.5 166.7 ATF1504AS-7 AC44 44A Commercial ATF1504AS-7 JC44 44J (0°C to 70°C) 68J ATF1504AS-7 JC68 84J ATF1504AS-7 JC84 ATF1504AS-7 QC100 100Q1 ATF1504AS-7 AC100 100A 125 44A 10 5 ATF1504AS-10 AC44 Commercial 44J (0°C to 70°C) ATF1504AS-10 JC44 68J ATF1504AS-10 JC68 ATF1504AS-10 JC84 84J ATF1504AS-10 QC100 100Q1 100A ATF1504AS-10 AC100 10 5 125 ATF1504AS-10 AI44 44A Industrial ATF1504AS-10 JI44 44J (-40°C to +85°C) ATF1504AS-10 JI68 68J ATF1504AS-10 JI84 84J ATF1504AS-10 QI100 100Q1 ATF1504AS-10 AI100 100A 15 8 100 ATF1504AS-15 AC44 44A Commercial ATF1504AS-15 JC44 44J (0°C to 70°C) 68J ATF1504AS-15 JC68 84J ATF1504AS-15 JC84 ATF1504AS-15 QC100 100Q1 ATF1500AS-15 AC100 100A 44A 15 8 100 ATF1504AS-15 AI44 Industrial 44J (-40°C to +85°C) ATF1504AS-15 JI44 68J ATF1504AS-15 JI68 84J ATF1504AS-15 JI84 ATF1504AS-15 QI100 100Q1 ATF1504AS-15 AI100 100A

# **ATF1504AS Ordering Information**

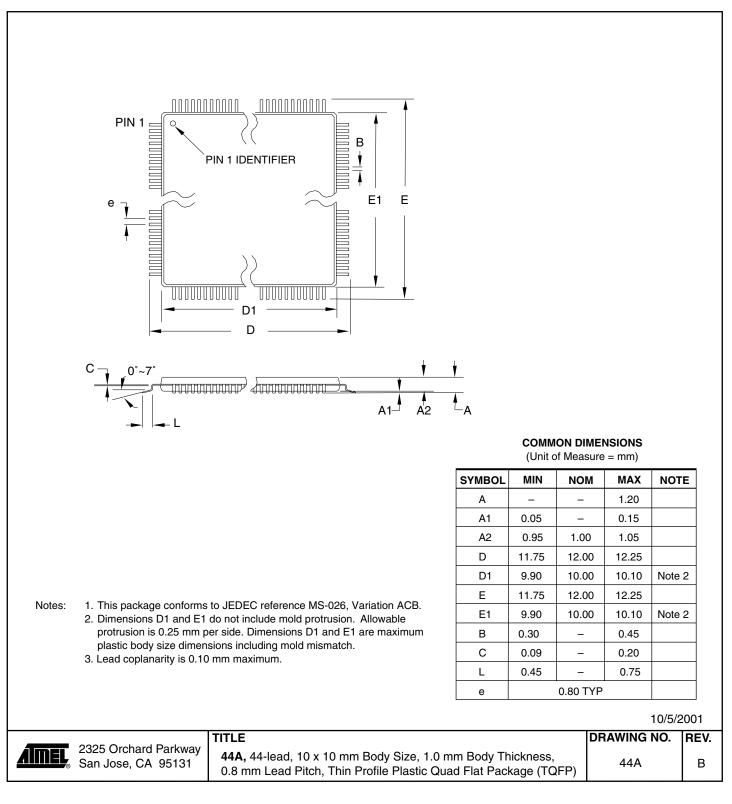
# Using "C" Product for Industrial

To use commercial product for Industrial temperature ranges, down-grade one speed grade from the "I" to the "C" device (7 ns "C" = 10 ns "I") and de-rate power by 30%.



# **Packaging Information**

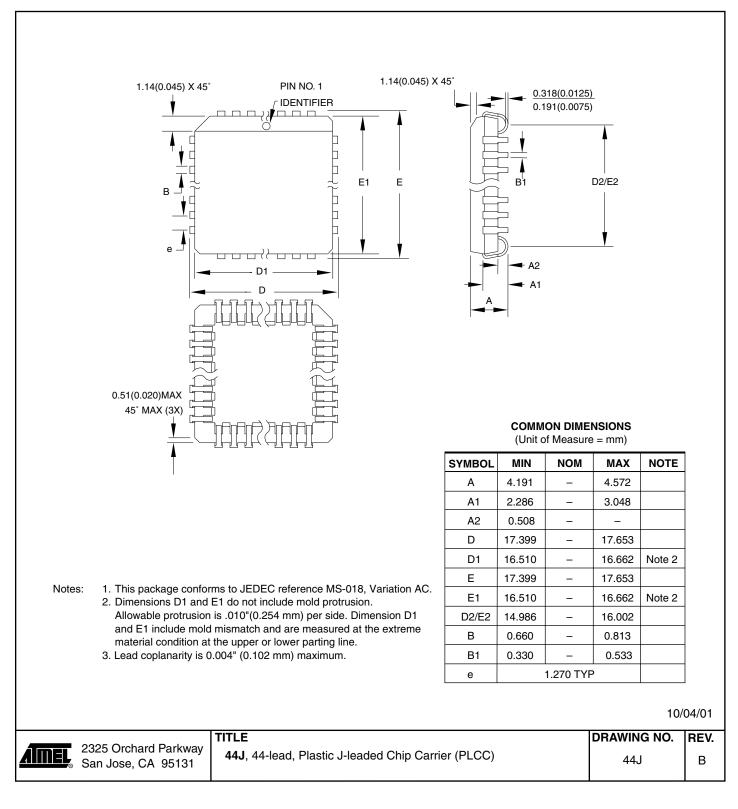
### 44A – TQFP





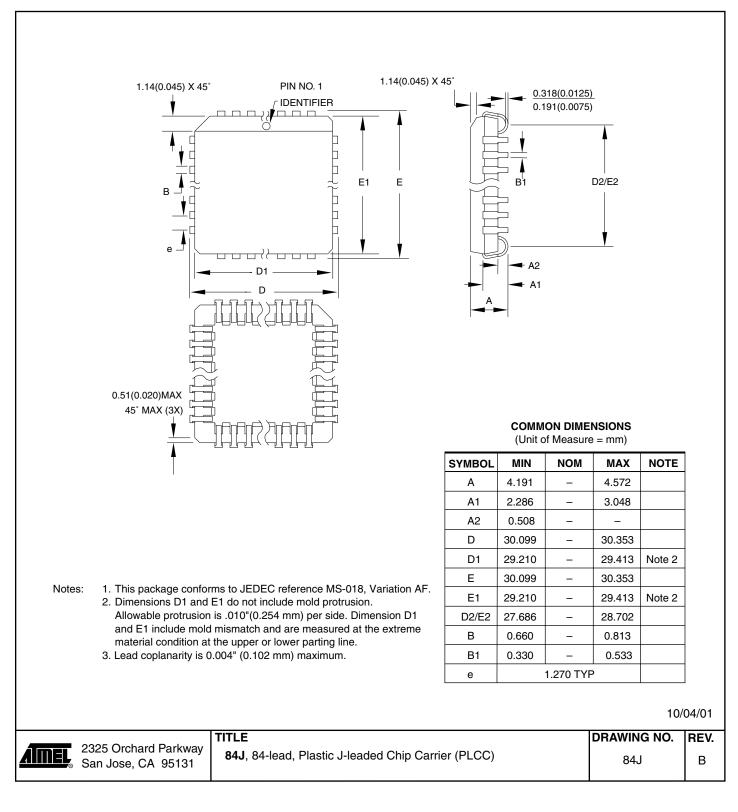


### 44J – PLCC

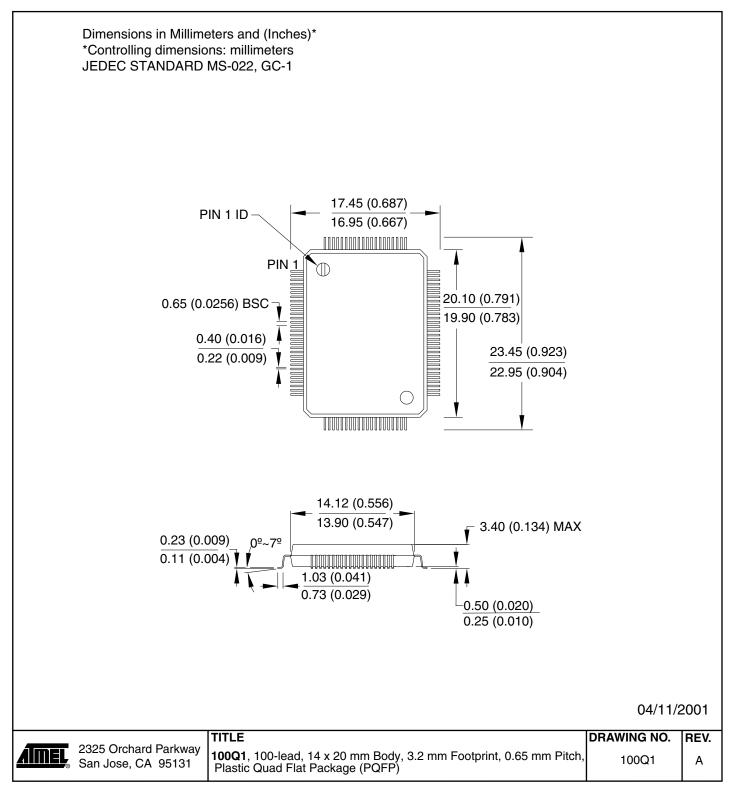




### 84J – PLCC



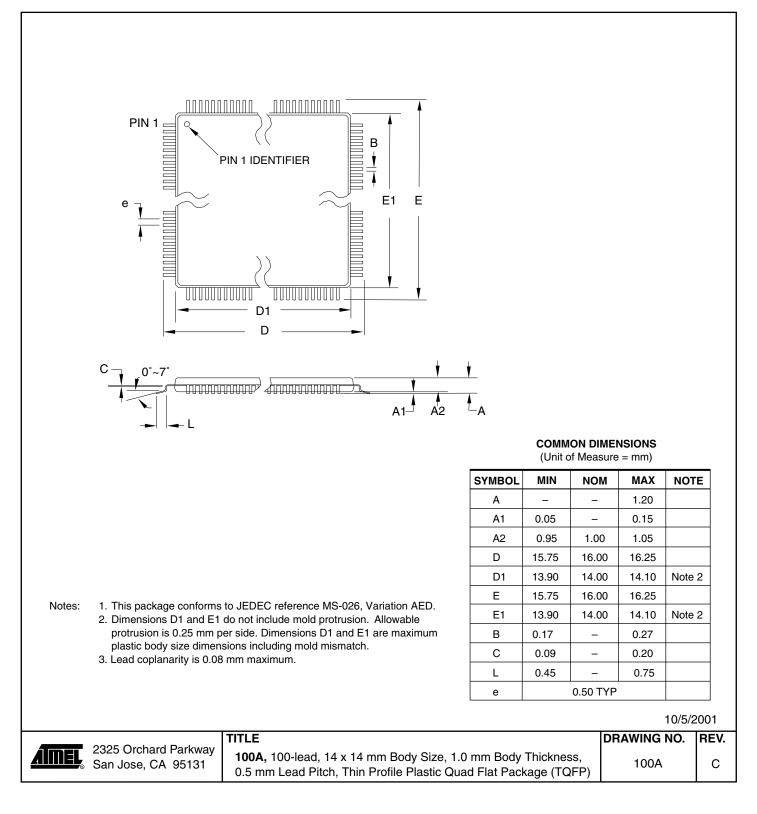
### 100Q1 - PQFP







### 100A – TQFP





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Scottish Enterprise Technology Park Maxwell Building East Kilbride G75 0QR, Scotland TEL (44) 1355-803-000 FAX (44) 1355-242-743 **RF**/Automotive

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